# 捷多邦,专业PCB打样工厂, SN74ALVCH162827 20-BIT BUFFER/DRIVER WITH 3-STATE OUTPUTS

SCES013H-JULY 1995-REVISED AUGUST 2004

#### **FEATURES**

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- Member of the Texas Instruments Widebus™
  Family
- Output Ports Have Equivalent 26- $\Omega$  Series Resistors, So No External Resistors Are Required
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)

#### **DESCRIPTION/ORDERING INFORMATION**

This 20-bit noninverting buffer/driver is designed for 1.65-V to 3.6-V  $V_{CC}$  operation.

The SN74ALVCH162827 is composed of two 10-bit sections with separate output-enable signals. For either 10-bit buffer section, the two output-enable (10E1 and 10E2 or 20E1 and 20E2) inputs must both be low for the corresponding Y outputs to be active. If either output-enable input is high, the outputs of that 10-bit buffer section are in the high-impedance state.

The outputs, which are designed to sink up to 12 mA, include equivalent 26- $\Omega$  resistors to reduce overshoot and undershoot.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

# DGG, DGV, OR DL PACKAGE (TOP VIEW)

	$\overline{}$	$\top$		
1 <del>0E1</del> [	1	O	56	10E2
1Y1 [	2		55	]1A1
1Y2[	3		54	1A2
GND [	4		53	GND
1Y3 [	5		52	1A3
1Y4 [	6		51	1A4
V <sub>CC</sub> [	7		50	] v <sub>cc</sub>
1Y [	8		49	] 1A5
1Y6 [	9		48	]1A6
1Y7 [	10		47	] 1A7
GND [	11		46	GND
1Y8 [	12		45	1A8
1Y9 [	13		44	1A9
1Y10[	14		43	1A10
2Y1 [	15		42	]2A1
2Y2	16		41	2A2
2Y3 [	17		40	P
GND [	18		39	GND
2Y4 [	19		38	]2A4
2Y5 [	20		37	] 2A5
2Y6 [	21		36	2A6
V <sub>CC</sub> [	22		35	] v <sub>cc</sub>
2Y7 [	23		34	2A7
2Y8 [	24		33	2A8
GND [	25		32	L 0.10
2Y9	26		31	E .
2Y10	27		30	2A10
2 <del>0E1</del> [	28		29	2 <del>0E</del> 2

Active bus-hold circuitry holds unused or undriven inputs at a valid logic state. Use of pullup or pulldown resistors with the bus-hold circuitry is not recommended.

# ORDERING INFORMATION

T <sub>A</sub>	PACKAGE <sup>(1)</sup>		ORDERABLE PART NUMBER	TOP-SIDE MARKING
	SSOB DI	Tube	SN74ALVCH162827DL	ALVCH162827
40°C to 95°C	SSOP - DL	Tape and reel	SN74ALVCH162827DLR	ALVCH102021
-40°C to 85°C	TSSOP - DGG	Tape and reel	SN74ALVCH162827GR	ALVCH162827
	TVSOP - DGV	Tape and reel	SN74ALVCH162827VR	VH2827

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

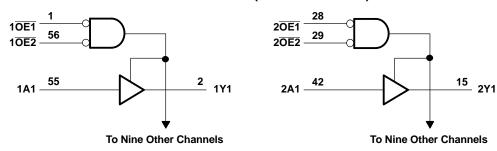
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# FUNCTION TABLE (each 10-bit section)

	INPUTS		OUTPUT
ŌE1	OE2	Α	Y
L	L	L	L
L	L	Н	н
Н	X	X	z
X	Н	X	z

# **LOGIC DIAGRAM (POSITIVE LOGIC)**



# ABSOLUTE MAXIMUM RATINGS(1)

over operating free-air temperature range (unless otherwise noted)

				MIN	MAX	UNIT	
V <sub>CC</sub>	Supply voltage range			-0.5	4.6	V	
VI	Input voltage range <sup>(2)</sup>			-0.5	4.6	V	
Vo	Output voltage range <sup>(2)(3)</sup>			-0.5	V <sub>CC</sub> + 0.5	V	
I <sub>IK</sub>	Input clamp current	V <sub>I</sub> < 0			-50	mA	
I <sub>OK</sub>	Output clamp current	V <sub>O</sub> < 0			-50	mA	
Io	Continuous output current			±50	mA		
	Continuous current through each V <sub>CC</sub>	or GND		-	±100	mA	
		DGG package		-	64		
$\theta_{JA}$	Package thermal impedance (4)	DGV package			48	°C/W	
		DL package			56		
T <sub>stg</sub>	Storage temperature range			-65	150	°C	

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.
- (3) This value is limited to 4.6 V maximum.
- (4) The package thermal impedance is calculated in accordance with JESD 51-7.



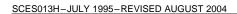
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# **RECOMMENDED OPERATING CONDITIONS**(1)

			MIN	MAX	UNIT	
V <sub>CC</sub>	Supply voltage		1.65	3.6	V	
		V <sub>CC</sub> = 1.65 V to 1.95 V	0.65 × V <sub>CC</sub>			
V <sub>IH</sub>	High-level input voltage	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.7		V	
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2			
		V <sub>CC</sub> = 1.65 V to 1.95 V		$0.35 \times V_{CC}$		
$V_{IL}$	Low-level input voltage	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		0.7	V	
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$		0.8		
V <sub>I</sub>	Input voltage	<u>.</u>	0	V <sub>CC</sub>	V	
Vo	Output voltage		0	V <sub>CC</sub>	V	
		V <sub>CC</sub> = 1.65 V		-2		
١.	High-level output current	V <sub>CC</sub> = 2.3 V		-6		
I <sub>OH</sub>		$V_{CC} = 2.7 \text{ V}$		-8	mA	
		V <sub>CC</sub> = 3 V		-12		
		V <sub>CC</sub> = 1.65 V		2		
١.	Lour lovel output ourrent	V <sub>CC</sub> = 2.3 V		6	mA	
loL	Low-level output current	V <sub>CC</sub> = 2.7 V		8		
		V <sub>CC</sub> = 3 V		12		
Δt/Δν	Input transition rise or fall rate	·		10	ns/V	
T <sub>A</sub>	Operating free-air temperature		-40	85	°C	

<sup>(1)</sup> All unused control inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

# SN74ALVCH162827 **20-BIT BUFFER/DRIVER WITH 3-STATE OUTPUTS**





# **ELECTRICAL CHARACTERISTICS**

over recommended operating free-air temperature range (unless otherwise noted)

P/	RAMETER	TEST CONDITIONS	V <sub>cc</sub>	MIN	TYP <sup>(1)</sup>	MAX	UNIT	
		I <sub>OH</sub> = -100 μA	1.65 V to 3.6 V	V <sub>CC</sub> - 0.2				
		$I_{OH} = -2 \text{ mA}$	1.65 V	1.2				
		$I_{OH} = -4 \text{ mA}$	2.3 V	1.9				
V <sub>OH</sub>		- 6 m \	2.3 V	1.7			V	
		I <sub>OH</sub> = -6 mA	3 V	2.4				
		$I_{OH} = -8 \text{ mA}$	2.7 V	2				
		I <sub>OH</sub> = -12 mA	3 V	2				
		$I_{OL} = 100 \mu A$	1.65 V to 3.6 V			0.2		
		I <sub>OL</sub> = 2 mA	1.65 V			0.45		
		I <sub>OL</sub> = 4 mA	2.3 V			0.4		
V <sub>OL</sub>		- 6 mA	2.3 V			0.55	V	
		I <sub>OL</sub> = 6 mA	3 V			0.55		
		I <sub>OL</sub> = 8 mA	2.7 V			0.6		
		I <sub>OL</sub> = 12 mA	3 V			0.8		
I		$V_I = V_{CC}$ or GND	3.6 V			±5	μΑ	
		V <sub>I</sub> = 0.58 V	1.65 V	25				
		V <sub>I</sub> = 1.07 V	1.65 V	-25				
		V <sub>I</sub> = 0.7 V	2.3 V	45				
I <sub>I(hold)</sub>		V <sub>I</sub> = 1.7 V	2.3 V	-45			μΑ	
		$V_1 = 0.8 \text{ V}$	3 V	75				
		V <sub>I</sub> = 2 V	3 V	-75				
		$V_1 = 0 \text{ to } 3.6 \text{ V}^{(2)}$	3.6 V			±500		
I <sub>OZ</sub>		$V_O = V_{CC}$ or GND	3.6 V			±10	μΑ	
Icc		$V_I = V_{CC}$ or GND, $I_O = 0$	3.6 V			40	μΑ	
$\Delta I_{CC}$		One input at $V_{CC}$ - 0.6 V, Other inputs at $V_{CC}$ or GND	3 V to 3.6 V			750	μΑ	
	Control inputs	V – V or GND	3.3 V	3.5			nE	
Ci	Data inputs	$V_I = V_{CC}$ or GND	3.3 V		6		pF	
Co	Outputs	$V_O = V_{CC}$ or GND	3.3 V		7		pF	

<sup>(1)</sup> All typical values are at  $V_{CC} = 3.3 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ . (2) This is the bus-hold maximum dynamic current. It is the minimum overdrive current required to switch the input from one state to



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## **SWITCHING CHARACTERISTICS**

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>CC</sub> = 1.8 V	$V_{CC} = 2.5 \text{ V} \\ \pm 0.2 \text{ V}$ $V_{CC} = 2.7 \text{ V}$		.7 V	/ V <sub>CC</sub> = 3.3 V ± 0.3 V		UNIT	
	(INPOT)	(001701)	TYP	MIN	MAX	MIN	MAX	MIN	MAX	
t <sub>pd</sub>	A	Y	(1)	1	4.4		4.4	1.5	3.8	ns
t <sub>en</sub>	ŌĒ	Y	(1)	1.4	6.3		6.2	1.6	5.1	ns
t <sub>dis</sub>	ŌĒ	Y	(1)	1.7	5.9		5.2	1.8	4.7	ns
t <sub>sk(LH)</sub> <sup>(2)</sup>	_		(1)		0.5		0.5		0.5	20
t <sub>sk(HL)</sub> <sup>(2)</sup>	A	r	(1)		0.5		0.5		0.5	ns

This information was not available at the time of publication.

Parameter specified by design

 $\begin{array}{l} t_{sk(LH)} = |t_{PLH}(m) - t_{PLH}(n)| \\ t_{sk(HL)} = |t_{PHL}(m) - t_{PHL}(n)| \\ \text{where m and n are any arbitrary data bits.} \end{array}$ 

## **OPERATING CHARACTERISTICS**

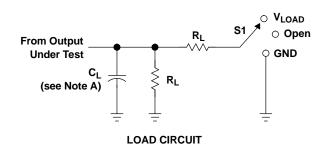
 $T_A = 25^{\circ}C$ 

PARAMETER		TEST CONDITIONS	V <sub>CC</sub> = 1.8 V TYP	V <sub>CC</sub> = 2.5 V TYP	V <sub>CC</sub> = 3.3 V TYP	UNIT	
	Dower dissination conscitance	Outputs enabled	C 50 pF 1 40 MHz	(1)	16	18	~F
C <sub>pd</sub>	Power dissipation capacitance	Outputs disabled	$C_L = 50 \text{ pF},  f = 10 \text{ MHz}$	(1)	4	6	p⊦

<sup>(1)</sup> This information was not available at the time of publication.

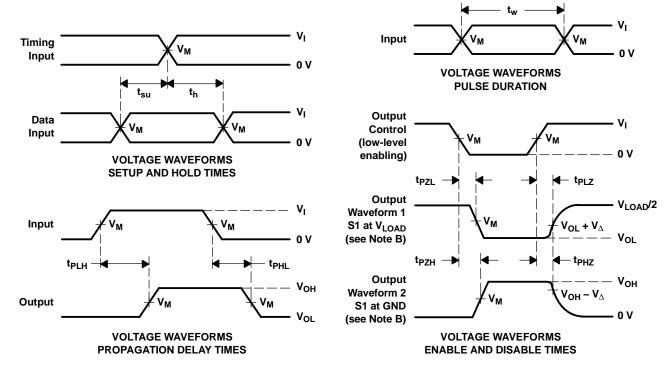


#### PARAMETER MEASUREMENT INFORMATION



TEST	<b>S</b> 1
t <sub>pd</sub>	Open
t <sub>PLZ</sub> /t <sub>PZL</sub>	V <sub>LOAD</sub>
t <sub>PHZ</sub> /t <sub>PZH</sub>	GND

.,	IN	PUT	, , , , , , , , , , , , , , , , , , ,		•	Б	.,
V <sub>CC</sub>	VI	t <sub>r</sub> /t <sub>f</sub>	V <sub>M</sub>	V <sub>LOAD</sub>	CL	R <sub>L</sub>	$oldsymbol{V}_{\Delta}$
1.8 V	v <sub>cc</sub>	≤2 ns	V <sub>CC</sub> /2	2×V <sub>CC</sub>	30 pF	<b>1 k</b> Ω	0.15 V
2.5 V $\pm$ 0.2 V	Vcc	≤2 ns	V <sub>CC</sub> /2	2×V <sub>CC</sub>	30 pF	500 Ω	0.15 V
2.7 V	2.7 V	≤2.5 ns	1.5 V	6 V	50 pF	500 Ω	0.3 V
3 V $\pm$ 0.3 V	2.7 V	≤2.5 ns	1.5 V	6 V	50 pF	500 Ω	0.3 V



NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

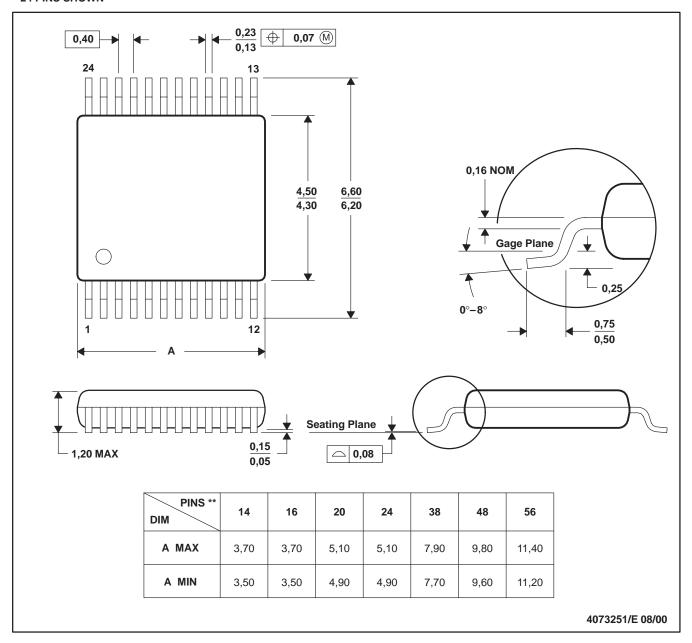
- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O = 50 \ \Omega$ .
- D. The outputs are measured one at a time, with one transition per measurement.
- E. t<sub>PLZ</sub> and t<sub>PHZ</sub> are the same as t<sub>dis</sub>.
- F. t<sub>PZL</sub> and t<sub>PZH</sub> are the same as t<sub>en</sub>.
- G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .
- H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

# DGV (R-PDSO-G\*\*)

## **24 PINS SHOWN**

# **PLASTIC SMALL-OUTLINE**



NOTES: A. All linear dimensions are in millimeters.

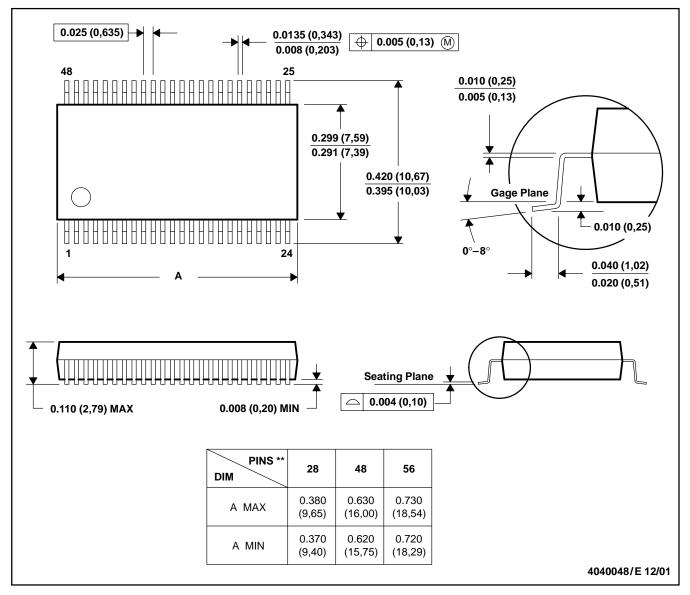
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.
- D. Falls within JEDEC: 24/48 Pins MO-153 14/16/20/56 Pins – MO-194



## DL (R-PDSO-G\*\*)

## **48 PINS SHOWN**

## PLASTIC SMALL-OUTLINE PACKAGE



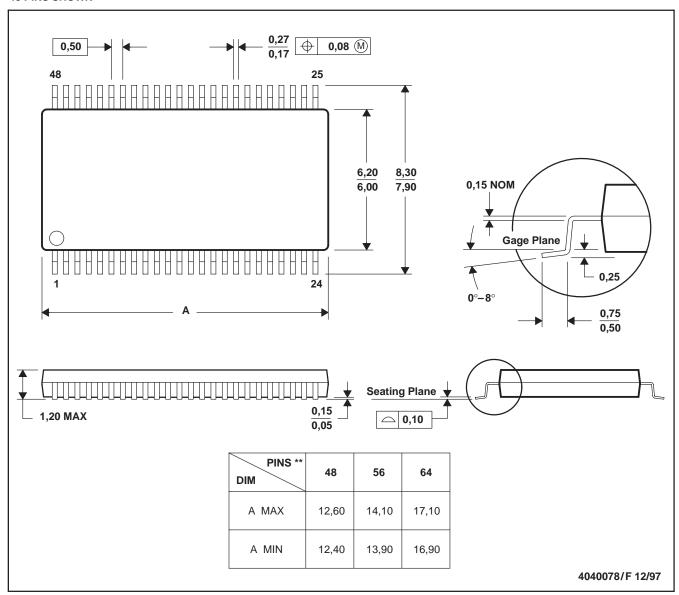
NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MO-118

# DGG (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE PACKAGE

## **48 PINS SHOWN**



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153



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Mailing Address: Texas Instruments

Post Office Box 655303 Dallas, Texas 75265